



Serial No. 09/225,198

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Date November 18, 2002

By: Carina M. Tan

DOCKET No.: 59501-8016.US01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE. APPLICATION OF:

*Cheyet et al.*

SERIAL No.: 09/225,198

FILED: 01/05/99

FOR: SOFTWARE-BASED ARCHITECTURE FOR  
COMMUNICATION AND COOPERATION  
AMONG DISTRIBUTED ELECTRONICS  
AGENTS

EXAMINER: Bullock Jr., L.

ART UNIT: 2151

**RECEIVED**

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Technology Center 2100

**DECLARATION UNDER 37 C.F.R. §1.132**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

I, Adam J. Cheyer, declare and affirm as follows:

1. I am a co-inventor, along with David L. Martin, of the subject matter described and claimed in U.S. Patent Application Serial No. 09/225,198, filed January 05, 1999, entitled SOFTWARE-BASED ARCHITECTURE FOR COMMUNICATION AND COOPERATION AMONG DISTRIBUTED ELECTRONICS AGENTS.

2. I am co-author of an article published in March, 1998, entitled "Building Distributed Software Systems with the Open Agent Architecture." The article included as co-authors, David L. Martin and Douglas B. Moran. Thus, the article was published less than one year from the filing date of the instant application.

3. I and David L. Martin are the inventors of the subject matter, which is claimed in claims 1-

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86 in the instant application.

4. Douglas B. Moran is not a co-inventor of the subject matter described in the subject matter disclosed and claimed in the instant application.

I declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Respectfully submitted,

11/15/02

Date

Adam J. Cheyer

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